



## General Information

**BALVER ZINN SOLDER SCA (SnCu0.7Ag0.3)** is a low cost lead free alloy for simple applications. **BALVER ZINN SOLDER SCA (SnCu0.7Ag0.3)** can be used for wave soldering, selective soldering and dip soldering applications. When using silver containing solders, the high copper dissolution may cause problems particularly at higher process temperatures and small line dimensions. For such applications **BALVER ZINN** recommends to use the highly reliable **BALVER ZINN SOLDER SN100C** to achieve a clear reduction of copper dissolution.

\***BALVER ZINN SOLDER SCA (SnCu0.7Cu0.3)** does not contain hazardous substances beyond the limits prescribed by EU Directive 2002/95/EG ("RoHS")

Further information are available in the **BALVER ZINN information „Lead free wave soldering.“** Technical information and further Technical Data Sheets can be found on our website ([www.BALVERZINN.com](http://www.BALVERZINN.com)). And of course, you can also obtain all information and documents directly from **BALVER ZINN**.

## BALVER ZINN Production Programme

The **BALVER ZINN** production programme also includes solder pastes, flux and solder wires. Beside the **SCA** product family, **BALVER ZINN** offers other unpatented and patented solder alloys for wave soldering, reflow and rework.

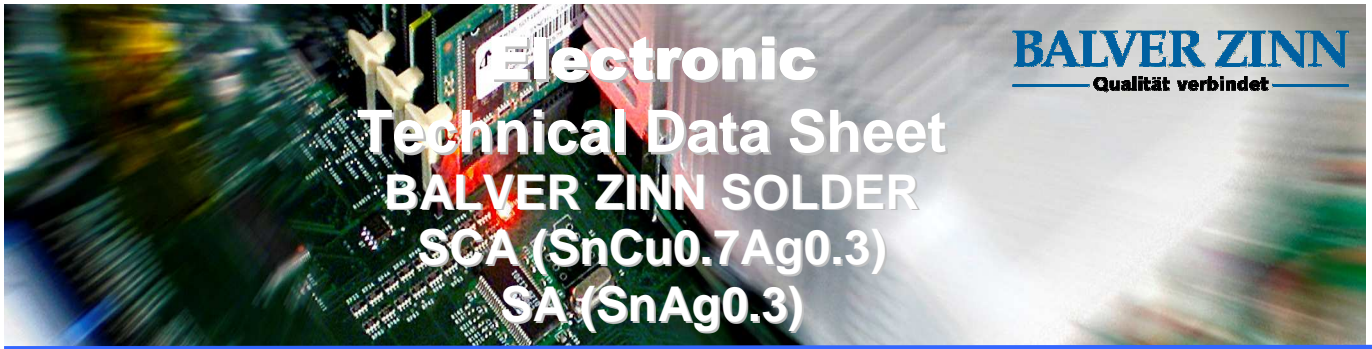
## General Process Information

To avoid high solder losses by dross, nitrogen hoods can be applied in wave soldering. Similar to all silver-containing solders with a high amount of tin, **BALVER ZINN SOLDER SCA (SnCu0.7Ag0.3)** severely affects pots and pumps, that therefore have to be coated sufficiently. Solder joints with **BALVER ZINN SOLDER SCA (SnCu0.7Ag0.3)** are not bright and shiny as with tin lead alloys. It shows a rough, coarse and dendritic structure, caused by the formation of primary tin crystals during the solidification of the molten metal. A differentiation between a good and a "cold" solder joint is not possible. **BALVER ZINN** conducts complimentary, regular solder bath analyses to determine the customer-specific bath top-up schedule and avoid problems caused by a too high level of impurities.

## Conditions for Wave Soldering

- Solder bath temperature 260-275°C.
- Before entering in the wave, the printed circuit boards should be 10–20°C warmer than for tin-lead Applications (Sn63Pb37). Usual conditions are 110-135°C, measured on the top side. The old rule applies: „Do not try to use the wave for preheating!"
- The contact time in the wave has to be increased due to the slower wetting in comparison with tin lead
- We recommend refilling with **BALVER ZINN SOLDER SA (SnAg0.3)**, to keep the copper content stable (all PCB surfaces except from NiAu).





**Physical properties of SCA in comparison with tin-lead**

	SCA SnCu0.7Ag0.3	SnPb37
Melting point °C	217 - 228	183
Specific Gravity g/cm <sup>3</sup>	7.37	8.4

**Delivery sizes**

Format		L mm	W mm	H mm
Ingots*	1 kg	325	28	15
	4 kg	300	50	40
Ingots with hole	3,7 kg	540	50	20
	6 kg	570	48	35
Bar		400x10x10		
Pellet		12 x 25		
Wire, solid, on reel		Ø 1.0 – 6.0		

\*Other dimensions on request.

**Composition of the Alloy**

Element	SCA SnCu0,7Ag0,3 in weight.-%	SA SnAg0,3 in weight.-%	Critical values in working solder bath*
Sn	Rest	Rest	Rest
Cu	0,6± 0,10	0,2 ± 0,1	< 0,4 > 0,85
Ag	0,30 ± 0,10	0,30 ± 0,10	> 1,00
Al	max. 0,001	max. 0,001	> 0,005
As	max. 0,03	max. 0,03	> 0,03
Au	max. 0,05	max. 0,05	K. A.
Bi	max. 0,03	max. 0,03	> 0,10
Cd	max. 0,002	max. 0,002	> 0,002
Fe	max. 0,02	max. 0,03	> 0,03
In	max. 0,05	max. 0,05	K. A.
Pb	max. 0,05	max. 0,05	> 0,10 (RoHS)
Sb	max. 0,05	max. 0,05	> 0,05
Zn	max. 0,001	max. 0,001	> 0,005

\*Max. solder bath impurities are not standardized, but are experience values.

**Storage Conditions / Durability**

Dry storage at room temperature / minimum 2 years

**Safety Advice**

Before using please refer to the appropriate Material Safety Data Sheet.

The information in this Data Sheet is based on data considered accurate. The measured values stated are based on own measurements, but do not represent assured properties or delivery specifications. Because of the vast number of different materials and applications – also with respect to possible protective rights of third parties – Balver Zinn Josef Jost GmbH & Co. KG **cannot** accept any liability.



**OUR GLOBAL PARTNERS FOR LEAD-FREE SOLDERS**

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